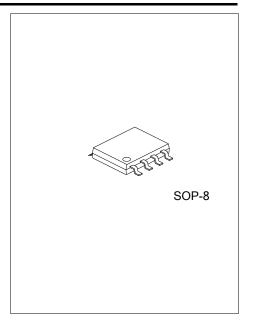
8A, 30V DUAL N-CHANNEL ENHANCEMENT MODE POWER MOSFET

■ DESCRIPTION

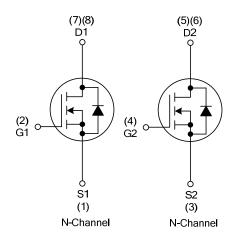
The UTC **UTT8NN03** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with low Rdson characteristic by high cell density trench technology.

■ FEATURES

- * $R_{DS(ON)}$ < 30 m Ω @ V_{GS} =10V, I_{D} =6.0A $R_{DS(ON)}$ < 40 m Ω @ V_{GS} =4.5V, I_{D} =3.0A
- * Fast Switching Speed
- * Simple Drive Requirement



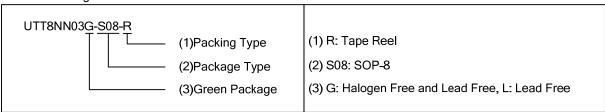
■ SYMBOL



■ ORDERING INFORMATION

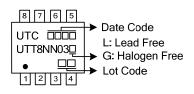
Ordering Number		Dookogo	Pin Assignment							Dooking	
Lead Free	Halogen Free	Package	1	2	3	4	5	6	7	8	Packing
UTT8NN03L-S08-R	UTT8NN03G-S08-R	SOP-8	S1	G1	S2	G2	D2	D2	D1	D1	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{ extsf{DSS}}$	30	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Drain Current	Continuous	I_{D}	8	Α	
	Pulsed (Note 2)	I_{DM}	32	Α	
Avalanche Energy Single Pulsed (Note 3)		E _{AS}	6	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.5	V/nS	
Power Dissipation		P_D	2.1	W	
Junction Temperature		T _J	+150	°C	
Storage Temperature		T_{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L =0.1mH, I_{AS} =11A, V_{DD} = 25V, R_G = 25 Ω , Starting T_J = 25°C.
- 4. $I_{SD} \le 8.0$ A, $di/dt \le 200$ A/ μ s, $V_{DD} \le V_{(BR)DSS}$, $T_J = 25$ °C.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	60	°C/W

Note: Device mounted on FR-4 substrate P_C board, 2oz copper, with 1inch square copper plate.

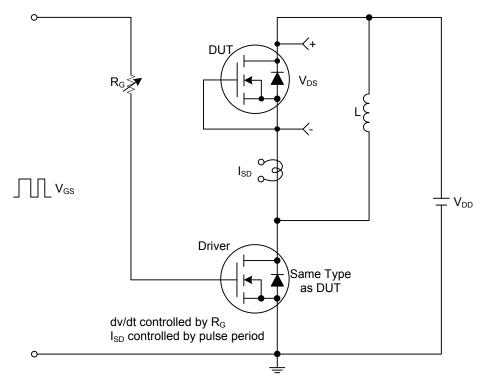
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

				_		_	
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							ā.
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	30			V
Drain-Source Leakage Current		I_{DSS}	V _{DS} =30V, V _{GS} =0V			1	μΑ
Gate-Source Leakage Current	Forward	1	V_{DS} =0 V , V_{GS} =20 V			30	nA
	Reverse	I _{GSS}	V_{DS} =0V , V_{GS} =-20V			-30	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0		3.0	V
Drain-Source On-State Resistar	200	R _{DS(ON)}	V _{GS} =10V, I _D =6.0A			30	mΩ
Diairi-Source Ori-State Resistar	ice		V _{GS} =4.5V, I _D =3.0A			40	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}			328		pF
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		51		pF
Reverse Transfer Capacitance		C_{RSS}			35		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	\/ -24\/ \/ -10\/ -9.04		11.7		nC
Gate-Source Charge		Q_GS	V_{DS} =24V, V_{GS} =10V, I_{D} =8.0A, I_{G} =1mA (Note 1, 2)		2.5		nC
Gate-Drain Charge		Q_GD	IG-IIIA (Note 1, 2)		2.5		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			9		ns
Turn-ON Rise Time		t_R	V_{DD} =15V, V_{GS} =10V, I_{D} =8.0A,		8		ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		30		ns
Turn-OFF Fall Time	Γurn-OFF Fall Time				19		ns
SOURCE- DRAIN DIODE RAT	INGS AND CH	ARACTERIS	STICS				
Maximum Body-Diode Continuous Current		I_S				8	Α
Maximum Body-Diode Pulsed Current		I _{SM}				32	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =8.0A, V _{GS} =0V			1.0	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =8.0A, V _{GS} =0V,		140		ns
Body Diode Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs		110		nC

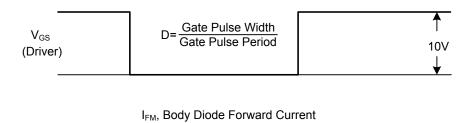
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

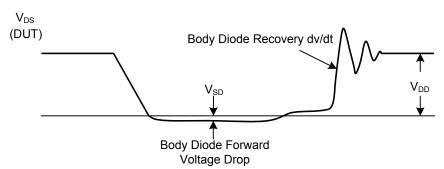
■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



Body Diode Reverse Current



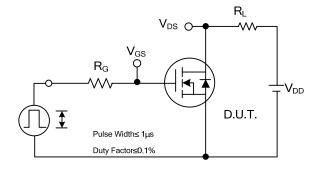
Peak Diode Recovery dv/dt Test Circuit and Waveforms

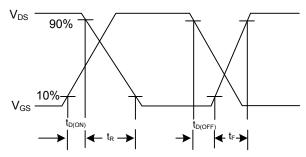
Peak Diode Recovery dv/dt Waveforms

 I_{SD}

(DUT)

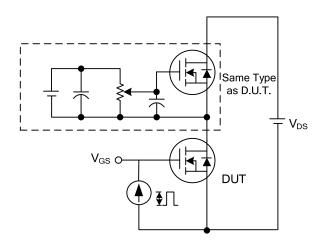
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

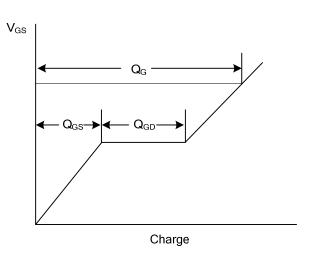




Switching Test Circuit

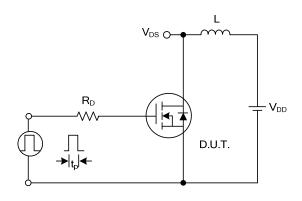
Switching Waveforms

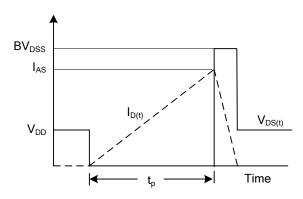




Gate Charge Test Circuit

Gate Charge Waveform

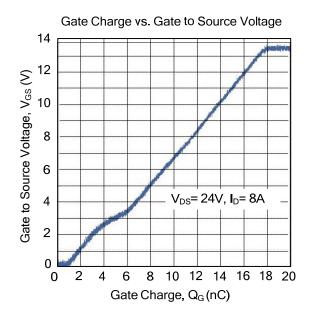


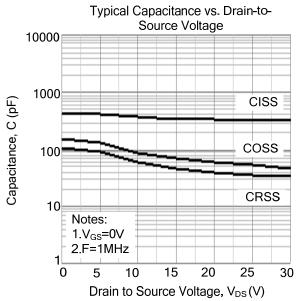


Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS





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